

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Switching Diode

DA2J10400L

Panasonic

DA2J10400L

Silicon epitaxial planar type

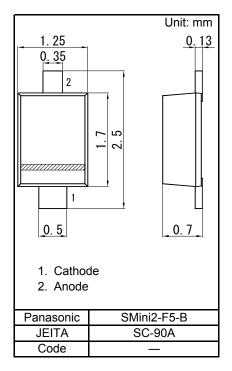
For high speed switching circuits

■ Features

- · Small reverse current IR
- · Low terminal capacitance Ct
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: C1

■ Packaging

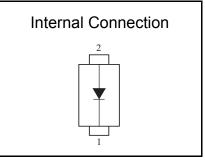
Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	80	V
Maximum peak reverse voltage	VRM	80	V
Forward current	IF	200	mA
Peak forward current	IFM	600	mA
Non-repetitive peak forward surge current *1	IFSM	1	Α
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

Note)*1: t = 1 s



Established: 2009-09-11 Revised: 2013-05-29

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■ Electrical Characteristics Ta = 25 °C ± 3 °C

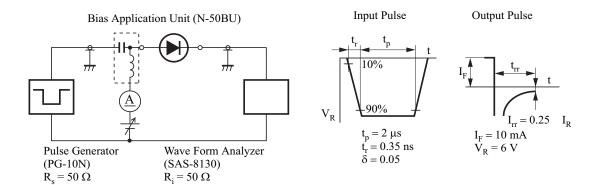
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 200 mA		0.90	1.10	V
Reverse voltage	VR	IR = 100 μA	80			V
Reverse current	IR	VR = 80 V			500	nA
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz			4	pF
Reverse recovery time *1	trr	IF = 10 mA, VR = 6 V			10	ns
		Irr = 0.25 × IR			10	

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - 2. Absolute frequency of input and output is 100 MHz.
 - 3. *1: trr test circuit

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Revised

: 2013-05-29



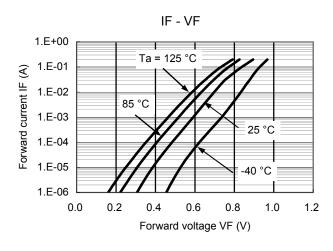
Panasonic

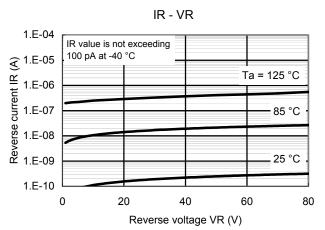
Revision. 3

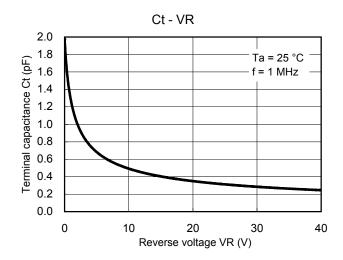
Switching Diode

DA2J10400L

Technical Data (reference)







Established: 2009-09-11 Revised: 2013-05-29

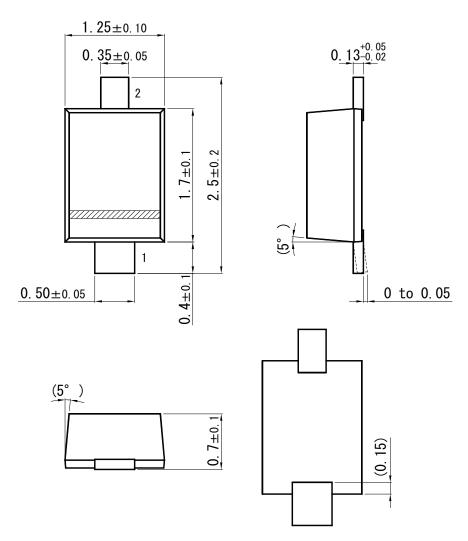
Switching Diode

DA2J10400L

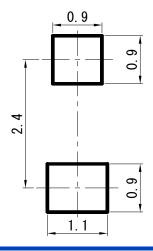
Panasonic

SMini2-F5-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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